

RC4861 1/2W Audio Power Amplifier with Shutdown

Features

- Low VOS, typically 2mV
- THD 0.3% typically at 0.5W output power
- Drives 8Ω and 4Ω non-powered speakers
- User programmable gain
- Internal thermal limiting circuitry
- 8 pin SOIC package

Applications

- · Multimedia PC motherboards and add-in sound cards
- · Companion chip to sigma-delta sound codecs
- Low power portable systems
- · Toys and games
- · Cellular phones

Description

The RC4861 sound driver is an audio device that can be used on PC motherboards and add-in sound cards. It consists of H-bridge connected output drivers for headphones or speakers.

The output drivers can deliver up to 0.5 Watt of continuous average output power into 8Ω speaker from a 5V source. The drivers use class AB amplifiers and maintain a low bias current. A shut down function disables the device for power savings when not in use.

The thermal limiting circuitry becomes active if the chip temperature exceeds 150°C.

Block Diagram



Rev. 0.9.3

Pin Assignments



Absolute Maximum Ratings

Supply Voltage, VDD	6.0V
Junction Temperature, TJ	150°C
Storage Temperature, TS	–65 to +150°C
Lead Soldering Temperature, 10 seconds	300°C
ESD Threshold, ESD (Human Body Model)	2000V

Note:

1. Functional operation under any of these conditions is not implied. Performance is guaranteed only if Operating Conditions are not exceeded

Operating Conditions

Parameter	Conditions	Min.	Тур.	Max.	Units
Power Supply, VDD		2.7	5.0	5.5	V
Input Voltage Logic High, VIH		VDD-0.8		Vdd	V
Input Voltage Logic Low, VIL				0.8	V
Ambient Operating Temperature, TA		0		70	°C

Electrical Characteristics

 V_{DD} = 5V, f = 1kHz, RL = 8 Ω , unless otherwise specified.

Parameter		Conditions	Min.	Тур.	Max.	Units
Av	Voltage Gain, Open Loop			90		dB
ISS	Shutdown current	Shutdown pin HIGH, VDD = 5V		0.6	10	μΑ
Itotal	Power Supply Current,	No load		6.5	10	mA
Vos	Output Offset Voltage	VIN = 0V		2	20	mV
Po	RMS Output Power	$R_L = 8\Omega$, $V_{DD} = 5V$	0.5			W
THD	Total Harmonic Distortion	fo = 1kHz, Po = 0.5W		0.3	1	%
PSRR	Power Supply Rejection Ratio Input Referenced	$f_O = 1$ kHz, $\Delta V_{DD} = 0.2$ Vp-p 0.1 μ F bypass cap	65	75		dB

Typical Application Circuit

(Demo board is available for circuit in Figure 1).





* Cs and CB size depend on specific application requirements and constraints. Typical values of Cs and CB are 0.1 μF **Pin 1 should be connected to VDD to disable the amplifier or to GND to enable the amplifier. This pin should not be left floating.

Single Ended Application Circuit



Figure 2. Single Ended Amplifier with Av= -1

* Cs and CB size depend on specific application requirements and constraints. Typical values of Cs and CB are 0.1 μF **Pin 1 should be connected to V_{DD} to disable the amplifier or to GND to enable the amplifier. This pin should not be left floating. ***These components create a "dummy" load for pin 8 for stability purposes.

External Components Description (for Figure 1)

Components	Functional Description			
Ri	Inverting input resistance which sets the closed-loop gain in conjunction with R_f . This resistor also forms a high pass filter with C_i at $f_c = 1/(2\pi R_i C_i)$.			
Ci	Input coupling capacitor which blocks DC voltage at the amplifier's input terminals. Also creates a highpass filter with R _i at f _C = $1/(2\pi R_i C_i)$.			
Rf	Feedback resistance which sets closed-loop gain in conjunction with R_i . Av = - R_f/R_i			
Cs	Supply bypass capacitor which provides power supply filtering.			
Св	Bypass pin capacitor which provides half supply filtering.			
Cf	Used when a differential gain of over 10 is desired. Cf in conjunction with Rf creates a low-pass filter which bandwidth limits the amplifier and prevents high frequency oscillation bursts. fC = $1/(2\pi Rf Cf)$			

Typical Performance Characteristics



Preliminary Information

Notes:

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Mechanical Dimensions – 8-Lead SOIC Package

Symbol	Inches		Millim	Notes	
Symbol	Min.	Max.	Min.	Max.	NOLES
Α	.053	.069	1.35	1.75	
A1	.004	.010	0.10	0.25	
В	.013	.020	0.33	0.51	
С	.008	.010	0.20	0.25	5
D	.189	.197	4.80	5.00	2
E	.150	.158	3.81	4.01	2
е	.050 BSC		1.27 BSC		
Н	.228	.244	5.79	6.20	
h	.010	.020	0.25	0.50	
L	.016	.050	0.40	1.27	3
Ν	8		8		6
α	0°	8°	0°	8°	
CCC	_	.004	_	0.10	

Notes:

- 1. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- 2. "D" and "E" do not include mold flash. Mold flash or protrusions shall not exceed .010 inch (0.25mm).
- 3. "L" is the length of terminal for soldering to a substrate.
- 4. Terminal numbers are shown for reference only.
- 5. "C" dimension does not include solder finish thickness.
- 6. Symbol "N" is the maximum number of terminals.







Ordering Information

Product Number	Package
RC4861M	8 pin SOIC

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